




TFW

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, with sufficient postage, in an envelope addressed to: Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450, on the below date:  
Date: 2/28/05 Name: Anthony P. Curtis, Ph.D., 46,193 Signature: 

BRINKS  
HOFER  
GILSON  
& LIONE

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Appln. of: Kuang Chien Hseih et al.  
Appln. No.: 10/680,509  
Filed: October 7, 2003  
For: Adhesive Bonding With Low Temperature Grown Amorphous or Polycrystalline Compound Semiconductors  
Attorney Docket No: 10322/57

Examiner: Vikki Trinh  
Art Unit: 2811

Mail Stop Amendment  
Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

**TRANSMITTAL**

Sir:

**Attached is/are:**

- ☒ Transmittal Cover Letter (1p. Filed in Dup.); Amendment (9pp.)
- ☒ Return Receipt Postcard

**Fee calculation:**

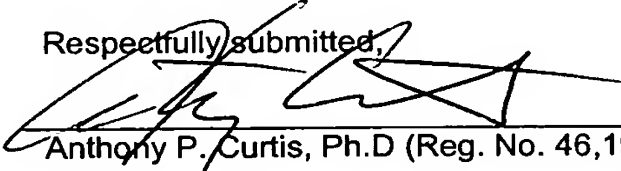
- ☒ No additional fee is required.
- ☐ Small Entity.
- ☐ An extension fee in an amount of \$\_\_\_\_\_ for a \_\_\_\_\_-month extension of time under 37 C.F.R. § 1.136(a).
- ☐ A petition or processing fee in an amount of \$\_\_\_\_\_ under 37 C.F.R. § 1.17(\_\_\_\_\_).
- ☐ An additional filing fee has been calculated as shown below:

					Small Entity			Not a Small Entity	
	Claims Remaining After Amendment		Highest No. Previously Paid For	Present Extra	Rate	Add'l Fee	or	Rate	Add'l Fee
Total	54	Minus	71	0	x \$25=			x \$50=	
Indep.	3	Minus	3	0	x 100=			x \$200=	
First Presentation of Multiple Dep. Claim					+\$180=			+\$360=	
					Total	\$		Total	\$

**Fee payment:**

- ☐ A check in the amount of \$\_\_\_\_\_ is enclosed.
- ☐ Please charge Deposit Account No. 23-1925 in the amount of \$\_\_\_\_\_. A copy of this Transmittal is enclosed for this purpose.
- ☐ Payment by credit card in the amount of \$\_\_\_\_\_ (Form PTO-2038 is attached).
- ☒ The Director is hereby authorized to charge payment of any additional filing fees required under 37 CFR § 1.16 and any patent application processing fees under 37 CFR § 1.17 associated with this paper (including any extension fee required to ensure that this paper is timely filed), or to credit any overpayment, to Deposit Account No. 23-1925.

2/28/05  
Date

Respectfully submitted,  
  
Anthony P. Curtis, Ph.D (Reg. No. 46,193)



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Commissioner for Patents  
P.O. Box 1450  
Alexandra, VA 22313-1450

on 2/28/05

Date of Deposit

Anthony P. Curtis, Ph.D., Reg. No. 46,193

Name of applicant, assignee or  
Registered Representative

Signature

2/28/05

Date of Signature

Our Case No. 10322/57

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Kuang Chien Hsieh et al.

Serial No. 10/680,509

Filing Date: October 7, 2003

For ADHESIVE BONDING WITH LOW  
TEMPERATURE GROWN  
AMORPHOUS OR  
POLYCRYSTALLINE COMPOUND  
SEMICONDUCTORS

Examiner: Vikki Trinh

Group Art Unit No. 2811

## AMENDMENT

Mail Stop AMENDMENT  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action of January 26, 2005, please amend the application as follows:

**Amendments to the Claims** begin on page 2 of this paper.

**Remarks** are provided on page 9 of this paper.